APPLICA	Operating				Storage				
	Operating Temperature Range 2 Voltage Current				Temperatur	e Range	-10 °C to 60 °C (2		(2)
Rating			Power Contact : 200 V AC		Storage Hur	orage Humidity Range Relat		tive humidity 85% max	
			Signal Contact : 0.5 A Power Contact : 3.0A			perating Humidity Range (Not dewed)			
			SPEC	IFICATIO	ONS				
IT	EM		TEST METHOD			REQU	IREMENTS	QT	A
CONSTRU	JCTION	•			•				
General Examination			Visually and by measuring instrument.			According to drawing.			>
Marking			Confirmed visually.					×	>
ELECTRIC CHARAC									
Contact Resistance		100 mA(DC	100 mA(DC or 1000Hz)			Signal Contact : 70m Ω MAX. Power Contact : 20m Ω MAX.			-
Insulation Resistance		-	Signal Contact : 100 V DC. Power Contact : 250 V DC			Signal Contact : 100 M Ω MIN. Power Contact : 1000 M Ω MIN.			-
Voltage Proof		Signal Cont	Signal Contact : 150 V AC for 1 min.			No flashover or breakdown.			>
			Power Contact : 600 V AC for 1 min.			X			
		RACTERIS							
Insertion and		Measured b	Measured by applicable connector.			Insertion Force: 9 N MAX.			-
Withdrawal Forces Mechanical Operation		100 +im	100 times insertions and extractions.			Withdrawal Force: 1 N MIN.			-
Mechanical Operation		100 times i	100 times insertions and extractions.			 Contact Resistance: Signal Contact : 80m Ω MAX. Power Contact : 30m Ω MAX. No damage, crack and looseness of parts. 			-
Vibration			Frequency 10 to 55 to 10Hz, approx 5min Single amplitude : 0.75 mm, 10 cycles			 No electrical discontinuity of 1 μs. No damage, crack and looseness of parts. 			-
Shock			for 3 axial directions. 490 m/s ² , duration of pulse 11 ms			0 /	·	×	-
			or 3 both axial directions.						
	MENTAL	CHARACTE							
Damp Heat		Exposed at	Exposed at 40±2 °C, 90 ~ 95 %, 96 h.			① Contact Resistance:			-
(Steady state) Rapid Change of		.				Signal Contact : $80m \Omega$ MAX. Power Contact : $30m \Omega$ MAX.			
Temperature		Time	Temperature-55 \rightarrow +85 °CTime30 \rightarrow 30 min.			2 Insulation Resistance:			-
remperature		under 5			-	Signal Contact			
			(Relocation time to chamber : within 2~3 MIN)			Power Contact			
Cold		Exposed at	Exposed at -55°C, 96 h			 Contact Resistance: Signal Contact : 80m Ω MAX. 			-
Dry Heat		Exposed at	Exposed at 105°C, 96 h			Power Contact : 30m Ω MAX. ② No damage, crack and looseness of parts.			-
Sulfur Dioxide		Exposed at	Exposed at 25±2°C, 75±5%RH, 25 PPM for 96 h. (Test standard: IEC 68) 1)Reflow soldering :			 No defect such as corrosion which impairs the function of connector. Contact Resistance: Signal Contact : 80m Ω MAX. Power Contact : 30m Ω MAX. No deformation of case of excessive 			1-
		(Test standa							
		1)Reflow so							+-
Soldering Heat		Peak TM	Peak TMP : 260°CMAX Reflow TMP: 220°CMIN for 60sec			looseness of the terminal.			
			irons : 360°C MAX. for 5	sec.					
Solderability			Soldered at solder temperature $240\pm3^{\circ}$ C for immersion duration, 3 sec.			A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.			-
						seu.			
COUN									
			-00002064		S. 00N0		HT. YAMAGUCHI	17.02.0	
REMARKS ⁽¹⁾ Include temperature rise caused by current-carrying. APPROVED ⁽²⁾ "STORAGE" means a long-term storage state for the unused product before assembly to PCB. CHECKED						HS. OKAWA KN. SHIBUYA	14. 07. 1 14. 07. 1		
						DESIGNED	TS. 00N0	14.07.1	
Unless otherwise specified, refer to IEC 60512.						DRAWN TS. 00N0)7.1
Note QT:Q			AT:Assurance Test X:Applicable Test			EV00 000		53551-00-00	
HRS		SPECIFICATION SHEET HIROSE ELECTRIC CO., LTD.			-		FX23-20S-0. 5SV	2	1/
					DDE NO.	DE NO. CL573-3201-0-00			1/